

P-Channel 30-V (D-S) MOSFET

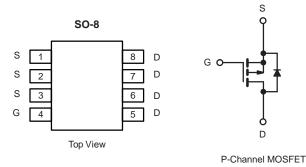
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)		
- 30	0.011 at V _{GS} = - 10 V	- 11.6	22 nC		
- 30	0.012 at V _{GS} = - 4.5 V	- 10	22 110		



- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

APPLICATIONS

- Load Switches
 - Notebook PCs
 - Desktop PCs



Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		- 11.6		
Continuous Drain Current (T_{I} = 150 °C)	T _C = 70 °C		- 10.5		
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	I _D	- 8.7 ^{a, b}		
	T _A = 70 °C		- 7.7 ^{a, b}	٨	
Pulsed Drain Current	I _{DM}	- 40	— A		
Continuous Course Durin Diada Current	T _C = 25 °C	1	- 4.6		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.0 ^{a, b}		
Avalanche Current L = 0.1 mH Single-Pulse Avalanche Energy L = 0.1 mH		I _{AS}	- 20		
		E _{AS}	20	mJ	
	T _C = 25 °C		5.6		
Maximum Dawar Dissinction	T _C = 70 °C		3.6	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{a, b}	VV	
	T _A = 70 °C		1.6 ^{a, b}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	39	50	°C/W
Maximum Junction-to-Foot	Steady State	R _{thJF}	18	22	0/00

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85 °C/W. d. Based on $T_C = 25$ °C.

HALOGEN

FREE Available

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SPECIFICATIONS T _J = 25 °C Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static	Symbol	Test conditions		тур.	IvidA.	Onit	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	VGS = 0 V, ID = 200 p. V	- 50	- 31			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		5.5		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	- 1.0	5.5	- 3.0	V	
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 25 \text{ V}$	- 1.0		± 100	nA	
Gale-Source Leakage	I _{GSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = -20 \text{ V}$			± 100	IIA	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 55 °C			- 5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge$ - 10 V, V_{GS} = - 10 V	- 30			Α	
	_	V _{GS} = - 10 V, I _D = - 10 A		0.011			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 7 A		0.012		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 10 A		23		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1960			
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		380		pF	
Reverse Transfer Capacitance	C _{rss}			325		1	
Total Gate Charge	Qg	V_{DS} = - 15 V, V_{GS} = - 10 V, I_{D} = - 10 A		43	65	nC	
	-			22	33		
Gate-Source Charge	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 10 A		6			
Gate-Drain Charge	Q _{gd}			11			
Gate Resistance	R _g	f = 1 MHz	0.3	1.3	2.5	Ω	
Turn-On Delay Time	t _{d(on)}			11	22		
Rise Time	t _r	V_{DD} = - 15 V, R _L = 3 Ω		13	25		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 5 A, V_{GEN} = - 10 V, R_g = 1 Ω		32	50		
Fall Time	t _f			9	18		
Turn-On Delay Time	t _{d(on)}			44	70	ns	
Rise Time	t _r	V_{DD} = - 15 V, R _L = 3 Ω		100	160	-	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 5 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		28	50		
Fall Time	t _f			15	30		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 4.6	^	
Pulse Diode Forward Current	I _{SM}				- 50	A	
Body Diode Voltage	V _{SD}	I _S = - 2 A, V _{GS} = 0 V		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			28	45	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	rI _F = - 2 A, dl/dt = 100 A/μs, T _J = 25 °C		20	40	nC	
Reverse Recovery Fall Time	t _a			13			
Reverse Recovery Rise Time	t _b			15		ns	

Notes:

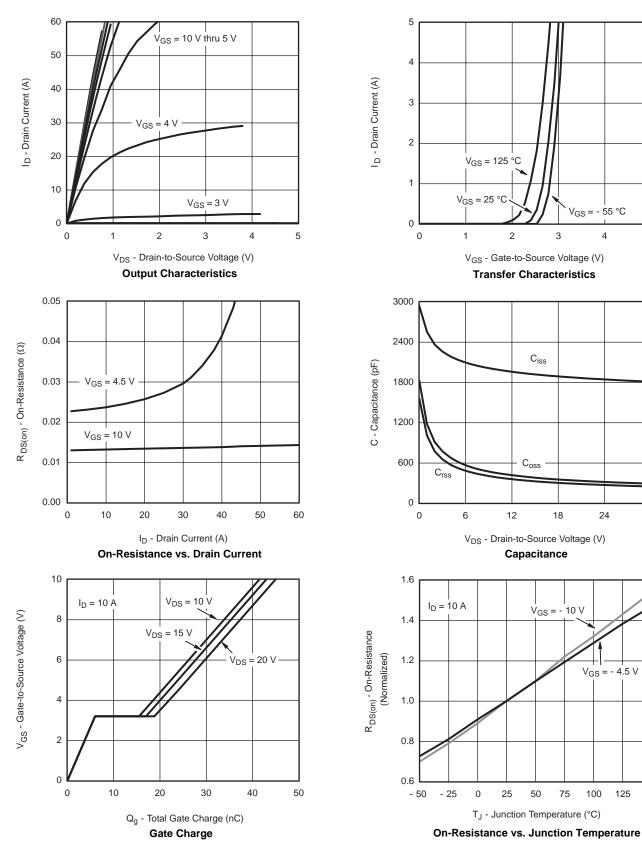
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

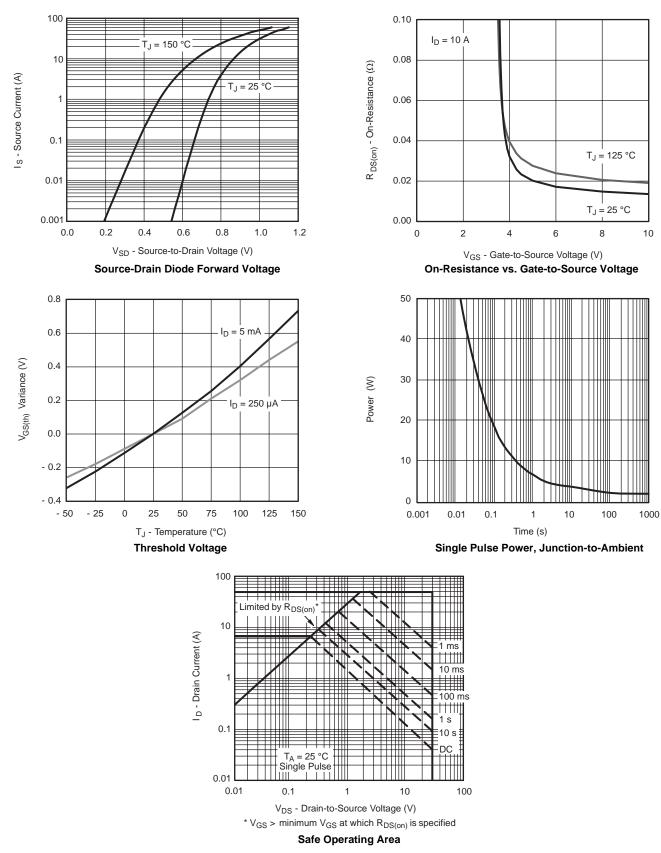
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



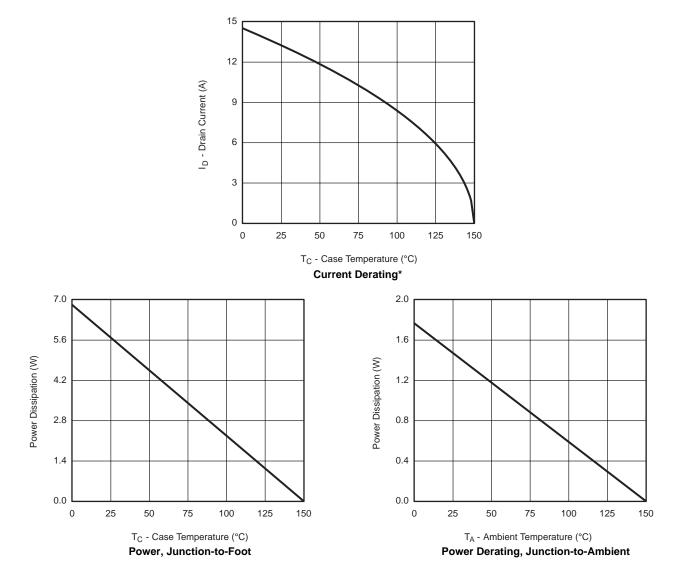




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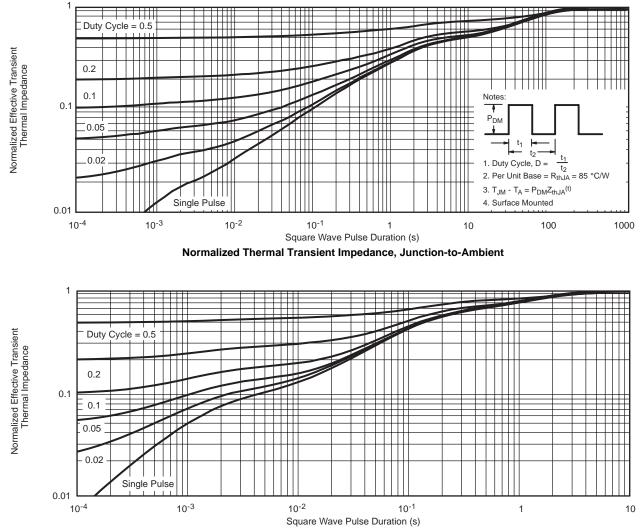
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

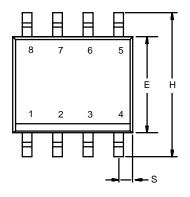


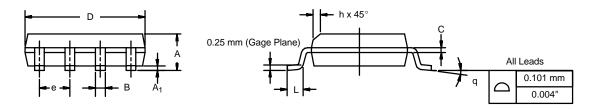
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

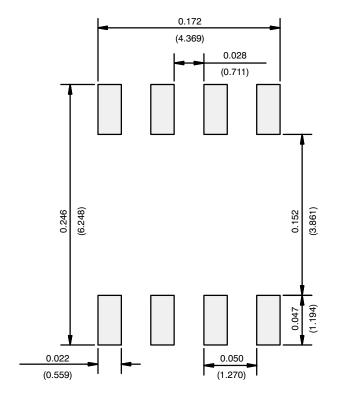




	MILLIMETERS		INC	HES	
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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